07/22/2014 502900994

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TUNG-CHOU HU	07/17/2014
HSIN-HUI LIEN	07/17/2014
SHENG-YU CHIU	07/17/2014

RECEIVING PARTY DATA

Name:	CORETRONIC CORPORATION
Street Address:	NO. 11, LI-HSIN RD., HSINCHU SCIENCE PARK,
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14334671

CORRESPONDENCE DATA

Fax Number: (510)580-7280

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE Correspondent Name:

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Address Line 4: TAIPEI, TAIWAN 100

ATTORNEY DOCKET NUMBER:	48553-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	07/22/2014

Total Attachments: 2

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> **PATENT REEL: 033357 FRAME: 0813** 502900994

ASSIGNMENT

WHEREAS,

1. Tung-Chou Hu

2. Hsin-Hui Lien

3. Sheng-Yu Chiu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CC

COLOR WHEEL MODULE AND PROJECTION APPARATUS

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Coretronic Corporation

of No. 11, Li-Hsin Rd., Hsinchu Science Park, Hsin-Chu 300, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have assigned and transferred, and by these presents does/do assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

indicated.	ed his/her/their name(s) on the date(s)			
Signature: Tung - Chon Hu	Date:Jul.17,2014			
Sole or First Joint Inventor: Tung-Chou Hu				
Signature: Hisin - Hui Lien	Date: Jul.17,2014			
Second Joint Inventor (if any): Hsin-Hui Lien				
Signature: Sheng-Ya Chin	Date: Jul.17,2014			
Third Joint Inventor (if any): Sheng-Yu Chiu				